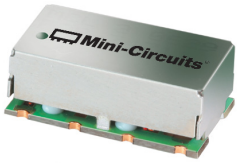
Surface Mount

Bandpass Filter

SXBP-70W+

50Ω 50 to 90 MHz



Generic photo used for illustration purposes only
CASE STYLE: HF1139

The Big Deal

- Very low insertion loss, 0.5dB typical
- Good VSWR, 1.3:1 typical
- Flat group delay response, 2 ns typical
- Miniature shielded package

Product Overview

SXBP-70W+ is a 50Ω bandpass filter in a shielded package fabricated using SMT technology. This bandpass filter covers from 50 to 90 MHz. This filter build with high Q capacitors and wire welded inductors for high reliability. This filter has sharper cut-off and well suited for IF signal processing applications.

Key Features

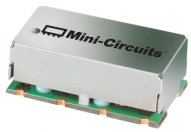
Feature	Advantages
Very low insertion loss, 0.5 dB typical	Can be used in telecommunication and broadband wireless application.
Good rejection	This enables the filter attenuate spurious signals and reject harmonics for broad frequency band.
Shielded package	The small surface mount package enables the SXBP-70W+ to be used in compact design

Surface Mount

Bandpass Filter

50Ω 50 to 90 MHz

SXBP-70W+



Generic photo used for illustration purposes only

CASE STYLE: HF1139

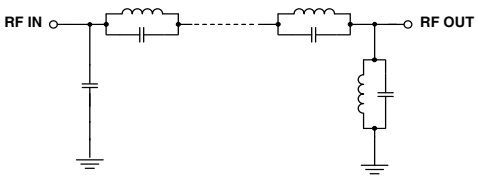
Features

- IF Frequency
- Very low insertion loss, 0.5 dB typical
- Flat group delay response, 2 ns typical
- Miniature shielded package

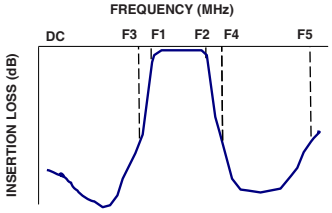
Applications

- Satellite base station
- IF signal processing
- Military hi-rel systems
- Harmonic rejection

Functional Schematic



Typical Frequency Response



+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Electrical Specifications at 25°C

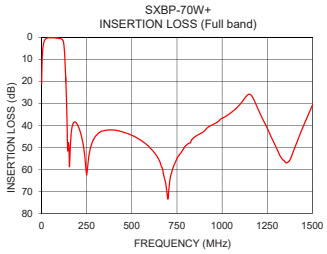
Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Center Frequency	—	—	—	70	—	MHz
	Insertion Loss	F1-F2	50-90	—	0.5	1.0	dB
	VSWR	F1-F2	50-90	—	1.3	1.7	:1
Stop Band, Lower	Insertion Loss	DC-F3	DC-2	10	14	—	dB
	VSWR	DC-F3	DC-2	—	20	—	:1
Stop Band, Upper	Insertion Loss	F4-F5	137-1500	20	23	—	dB
	VSWR	F4-F5	137-1500	—	20	—	:1

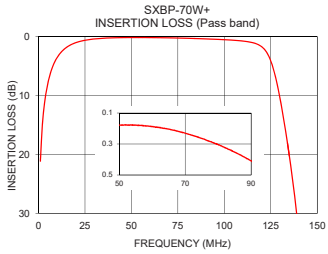
Maximum Ratings	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power Input	0.5W

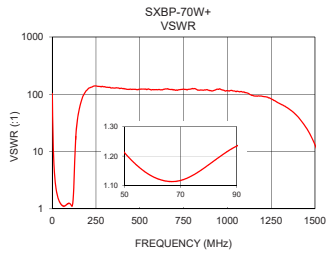
Permanent damage may occur if any of these limits are exceeded.

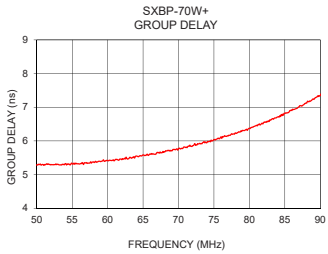
Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Group Delay (nsec)
1	21.14	103.07	50	5.29
2	15.26	61.74	52	5.30
3	11.91	38.00	54	5.32
4	9.63	25.35	56	5.31
5	7.95	18.09	58	5.38
6	6.65	13.62	60	5.41
11	3.11	5.43	62	5.44
50	0.18	1.21	64	5.55
70	0.23	1.12	66	5.61
90	0.41	1.23	68	5.68
100	0.54	1.24	70	5.77
124	3.38	2.57	72	5.86
130	10.52	8.60	74	5.95
135	20.24	18.34	76	6.12
137	24.88	22.39	78	6.24
139	30.16	26.24	80	6.38
140	33.15	28.19	82	6.54
500	44.54	122.40	84	6.71
1250	41.34	83.38	86	6.90
1500	30.88	13.12	90	7.35









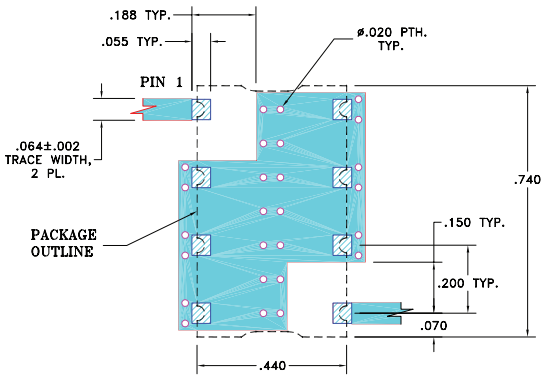
Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Pad Connections

INPUT	1
OUTPUT	8
GROUND	2,3,4,5,6,7

Demo Board MCL P/N: TB-368
Suggested PCB Layout (PL-230)



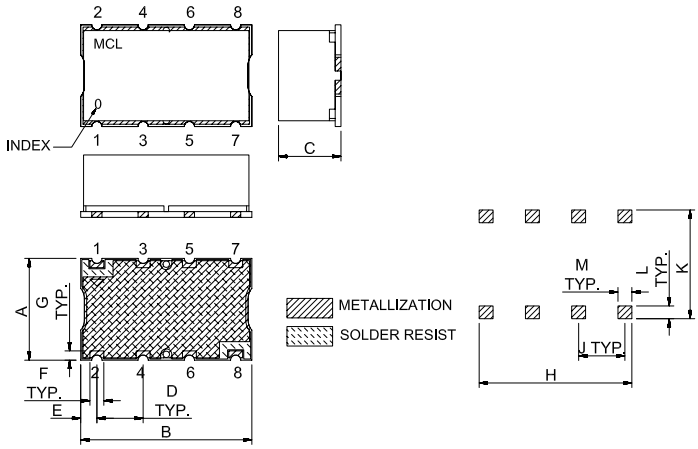
NOTE:

1. TRACE WIDTH IS SHOWN FOR FR4 WITH DIELECTRIC THICKNESS: .025"±.002". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Outline Drawing



Outline Dimensions (inch / mm)

A	B	C	D	E	F	G
.44	.74	.27	.200	.07	.060	.040
11.18	18.80	6.86	5.08	1.78	1.52	1.02
H	J	K	L	M		wt
.660	.200	.470	.055	.060		grams
16.76	5.08	11.94	1.40	1.52		3.0

Note: Please refer to case style drawing for details

Surface Mount Band Pass Filter SXBP-70W+

Typical Performance Data

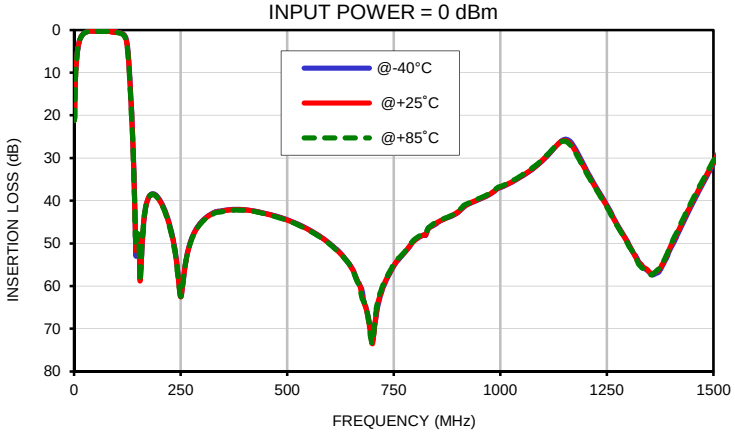
FREQ.	INSERTION LOSS			INPUT RETURN LOSS			OUTPUT RETURN LOSS		
(MHz)	(dB)			(dB)			(dB)		
	@-40°C	@+25°C	@+85°C	@-40°C	@+25°C	@+85°C	@-40°C	@+25°C	@+85°C
1	21.15	21.14	21.15	0.15	0.17	0.19	0.10	0.11	0.12
2	15.27	15.26	15.26	0.26	0.28	0.30	0.21	0.21	0.22
3	11.92	11.91	11.91	0.44	0.46	0.47	0.37	0.38	0.39
4	9.64	9.63	9.63	0.66	0.69	0.70	0.59	0.60	0.61
5	7.95	7.95	7.95	0.94	0.96	0.98	0.86	0.87	0.88
6	6.66	6.65	6.66	1.25	1.28	1.30	1.17	1.18	1.19
7	5.63	5.63	5.64	1.60	1.63	1.65	1.52	1.53	1.54
8	4.80	4.80	4.81	1.98	2.00	2.02	1.89	1.90	1.91
9	4.12	4.13	4.14	2.38	2.40	2.42	2.28	2.29	2.30
10	3.56	3.58	3.58	2.79	2.81	2.83	2.69	2.70	2.71
11	3.10	3.11	3.12	3.22	3.24	3.25	3.12	3.13	3.13
12	2.70	2.72	2.73	3.65	3.67	3.69	3.56	3.56	3.56
13	2.37	2.38	2.39	4.10	4.11	4.13	4.00	4.00	4.00
14	2.08	2.10	2.11	4.55	4.56	4.57	4.45	4.44	4.45
15	1.84	1.85	1.87	5.00	5.01	5.02	4.90	4.90	4.90
17	1.45	1.46	1.48	5.91	5.91	5.92	5.82	5.80	5.80
18	1.29	1.31	1.32	6.37	6.36	6.36	6.28	6.26	6.25
20	1.04	1.05	1.07	7.28	7.27	7.26	7.19	7.16	7.15
25	0.62	0.64	0.66	9.56	9.51	9.49	9.50	9.44	9.42
30	0.40	0.41	0.43	11.79	11.73	11.69	11.81	11.75	11.71
35	0.28	0.29	0.31	14.00	13.94	13.88	14.16	14.09	14.05
40	0.21	0.23	0.24	16.17	16.12	16.07	16.54	16.49	16.45
45	0.18	0.19	0.20	18.31	18.29	18.23	18.94	18.91	18.89
50	0.16	0.18	0.19	20.43	20.41	20.34	21.37	21.31	21.28
55	0.16	0.18	0.20	22.56	22.42	22.28	23.68	23.43	23.29
60	0.17	0.19	0.21	24.76	24.26	23.93	25.62	24.89	24.48
70	0.20	0.23	0.26	26.53	25.15	24.38	25.44	24.24	23.53
80	0.27	0.30	0.33	22.72	22.08	21.63	21.75	21.25	20.87
90	0.37	0.41	0.44	19.79	19.60	19.41	19.31	19.23	19.11
100	0.49	0.54	0.59	19.44	19.36	19.24	19.29	19.39	19.40
110	0.69	0.77	0.84	23.71	23.63	23.51	22.66	22.69	22.65
120	1.50	1.70	1.86	14.84	13.90	13.41	14.96	14.26	13.84
125	3.72	4.13	4.44	6.09	5.83	5.68	6.60	6.49	6.41
130	9.98	10.52	10.93	1.97	2.03	2.07	2.35	2.50	2.60
132	13.55	14.10	14.51	1.33	1.42	1.48	1.66	1.83	1.93
135	19.68	20.24	20.68	0.85	0.95	1.01	1.11	1.26	1.36
136	21.93	22.50	22.95	0.76	0.85	0.92	1.00	1.14	1.24
137	24.29	24.88	25.35	0.68	0.78	0.84	0.90	1.04	1.13
138	26.81	27.43	27.92	0.62	0.71	0.78	0.83	0.96	1.04
139	29.50	30.16	30.68	0.57	0.66	0.72	0.76	0.88	0.97
140	32.44	33.15	33.71	0.53	0.62	0.67	0.71	0.82	0.90
142	39.48	40.32	41.00	0.46	0.55	0.60	0.62	0.72	0.79
144	49.24	49.59	49.64	0.41	0.49	0.54	0.55	0.64	0.70
145	52.95	51.66	50.74	0.39	0.46	0.51	0.51	0.60	0.66
150	48.25	48.25	48.18	0.31	0.38	0.42	0.40	0.47	0.52
200	39.65	39.85	39.96	0.12	0.15	0.16	0.14	0.16	0.17
250	62.45	62.55	62.46	0.11	0.12	0.14	0.12	0.13	0.13
300	44.78	44.93	45.02	0.12	0.13	0.14	0.11	0.13	0.13
350	42.33	42.39	42.50	0.12	0.14	0.15	0.11	0.13	0.14
400	42.12	42.17	42.25	0.12	0.14	0.15	0.10	0.13	0.13
500	44.45	44.54	44.64	0.12	0.14	0.16	0.10	0.13	0.14
750	55.31	55.13	54.82	0.11	0.14	0.15	0.10	0.14	0.15
800	49.23	49.18	48.93	0.10	0.14	0.15	0.10	0.14	0.15
950	39.71	39.62	39.45	0.09	0.14	0.15	0.12	0.18	0.20
1000	36.92	36.87	36.68	0.09	0.15	0.16	0.16	0.23	0.27
1100	30.55	30.41	30.21	0.09	0.16	0.18	0.77	0.99	1.17
1200	32.45	32.86	33.13	0.10	0.19	0.20	1.31	1.42	1.49
1300	49.94	50.14	50.43	0.15	0.25	0.28	0.20	0.27	0.31
1400	51.11	50.52	50.30	0.27	0.42	0.48	0.08	0.15	0.19
1500	31.32	30.88	30.51	1.00	1.33	1.52	0.06	0.14	0.18

Typical Performance Data

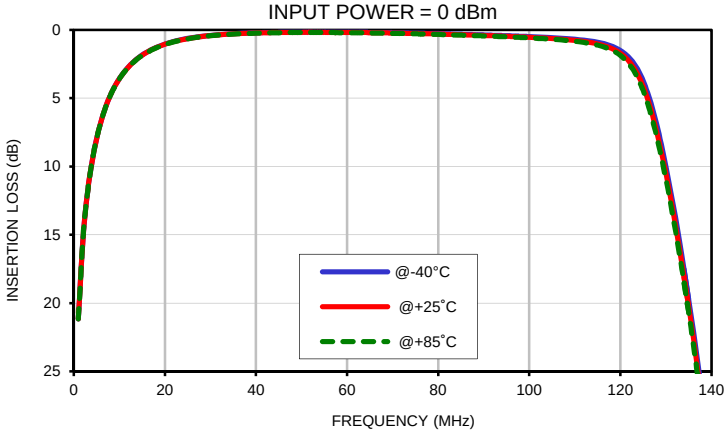
FREQ. (MHz)	GROUP DELAY (nsec)		
	@-40°C	@+25°C	@+85°C
50.0	5.29	5.29	5.29
50.5	5.30	5.31	5.32
51.0	5.27	5.27	5.29
51.5	5.30	5.30	5.33
52.0	5.30	5.30	5.31
52.5	5.29	5.30	5.31
53.0	5.30	5.31	5.32
53.5	5.29	5.29	5.31
54.0	5.30	5.32	5.34
54.5	5.30	5.32	5.32
55.0	5.31	5.32	5.31
55.5	5.31	5.32	5.33
56.0	5.31	5.31	5.33
56.5	5.33	5.33	5.35
57.0	5.36	5.36	5.36
57.5	5.35	5.35	5.36
58.0	5.35	5.38	5.38
58.5	5.39	5.38	5.40
59.0	5.39	5.38	5.39
59.5	5.40	5.40	5.41
60.0	5.41	5.41	5.44
60.5	5.42	5.42	5.42
61.0	5.43	5.42	5.45
61.5	5.43	5.43	5.45
62.0	5.44	5.44	5.45
62.5	5.47	5.46	5.49
63.0	5.47	5.48	5.49
63.5	5.51	5.51	5.53
64.0	5.54	5.55	5.54
64.5	5.54	5.55	5.57
65.0	5.59	5.59	5.59
65.5	5.56	5.59	5.60
68.0	5.68	5.68	5.69
70.0	5.76	5.77	5.77
72.0	5.85	5.86	5.87
74.0	5.93	5.95	5.96
75.0	6.05	6.04	6.05
79.0	6.29	6.31	6.31
79.5	6.34	6.33	6.35
80.0	6.35	6.38	6.39
80.5	6.40	6.41	6.41
81.0	6.45	6.46	6.48
81.5	6.46	6.47	6.49
82.0	6.52	6.54	6.55
82.5	6.56	6.58	6.59
83.0	6.62	6.62	6.64
83.5	6.64	6.67	6.67
84.0	6.69	6.71	6.73
84.5	6.76	6.78	6.77
85.0	6.81	6.81	6.84
85.5	6.84	6.84	6.87
86.0	6.88	6.90	6.91
86.5	6.92	6.95	6.98
87.0	6.98	7.01	7.01
87.5	7.04	7.05	7.07
88.0	7.09	7.13	7.14
88.5	7.16	7.19	7.19
89.0	7.21	7.25	7.27
89.5	7.28	7.31	7.32
90.0	7.33	7.35	7.37

Typical Performance Curves

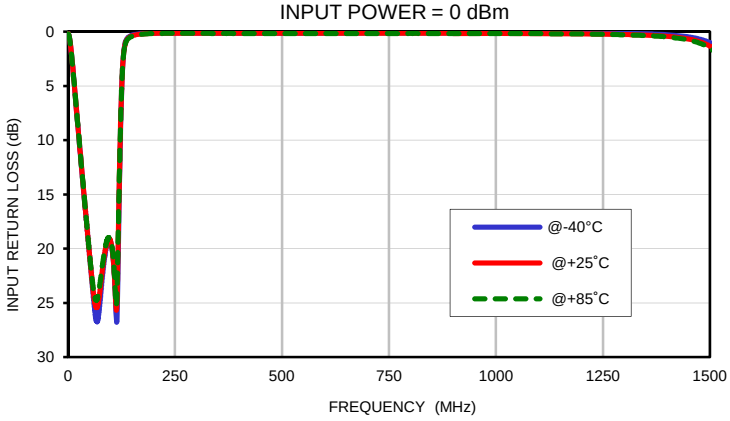
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



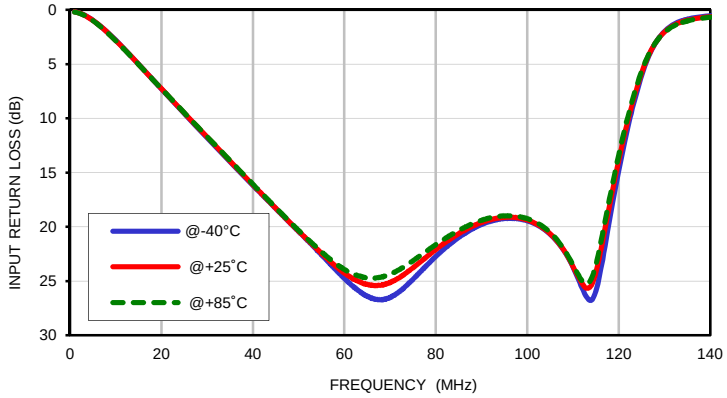
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



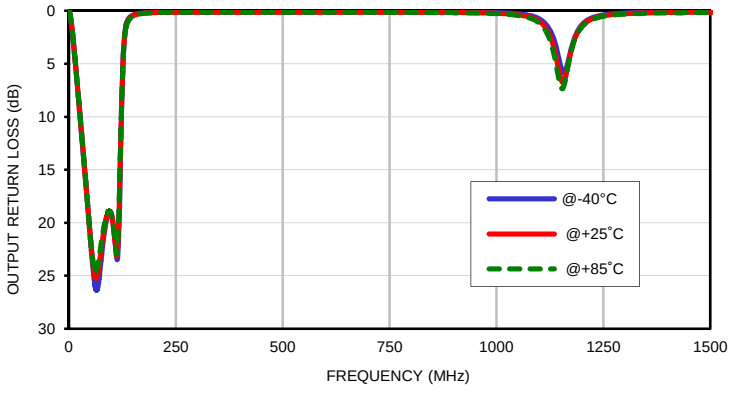
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



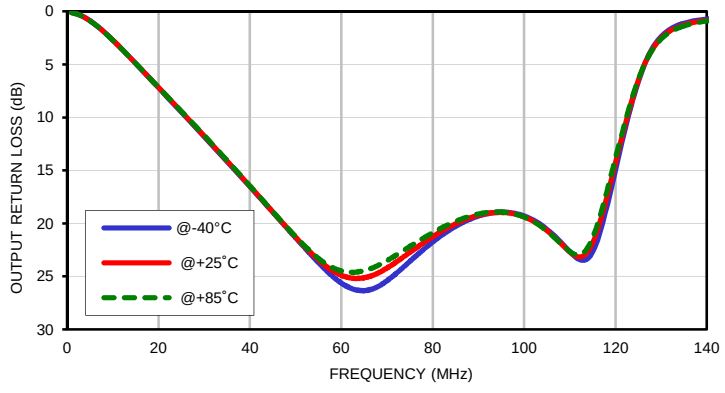
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



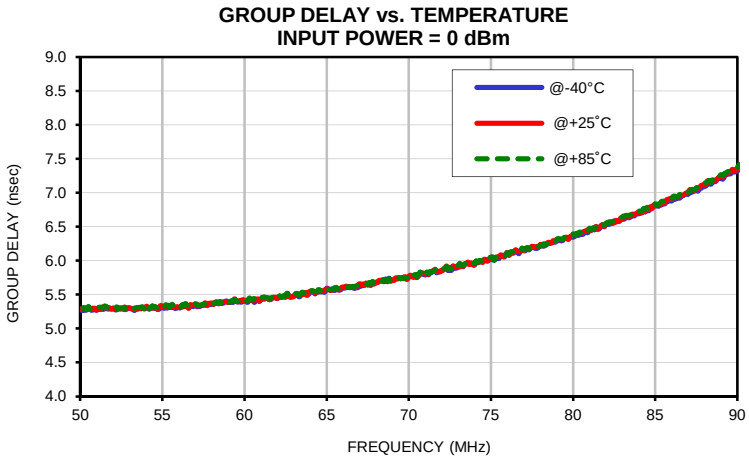
OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



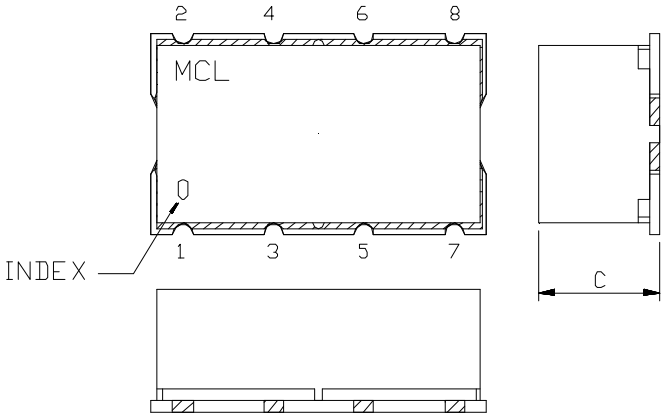
Typical Performance Curves

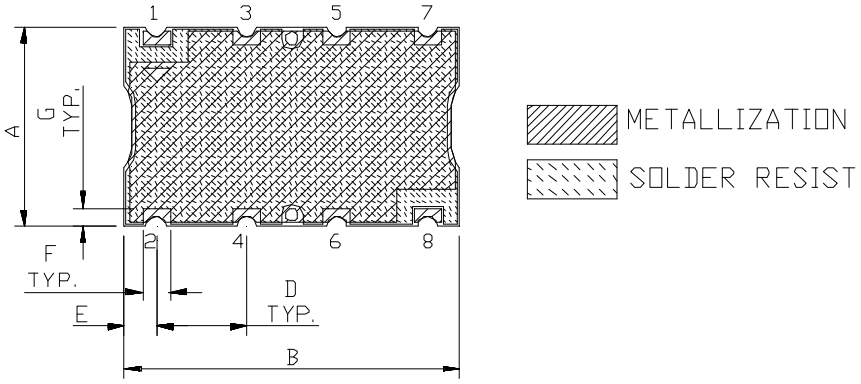


Case Style HF

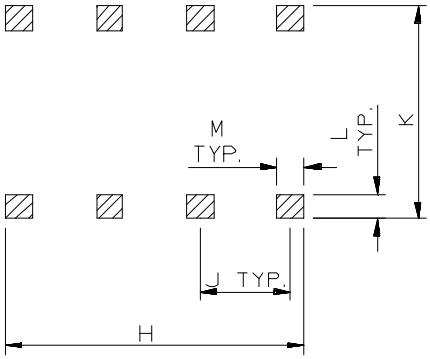
HF1139

Outline Dimensions





PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
HF1139	.44 (11.18)	.74 (18.80)	.27 (6.86)	.200 (5.08)	.07 (1.78)	.060 (1.52)	.040 (1.02)	.660 (16.76)	.200 (5.08)	.470 (11.94)	.055 (1.40)	.060 (1.52)	3.0

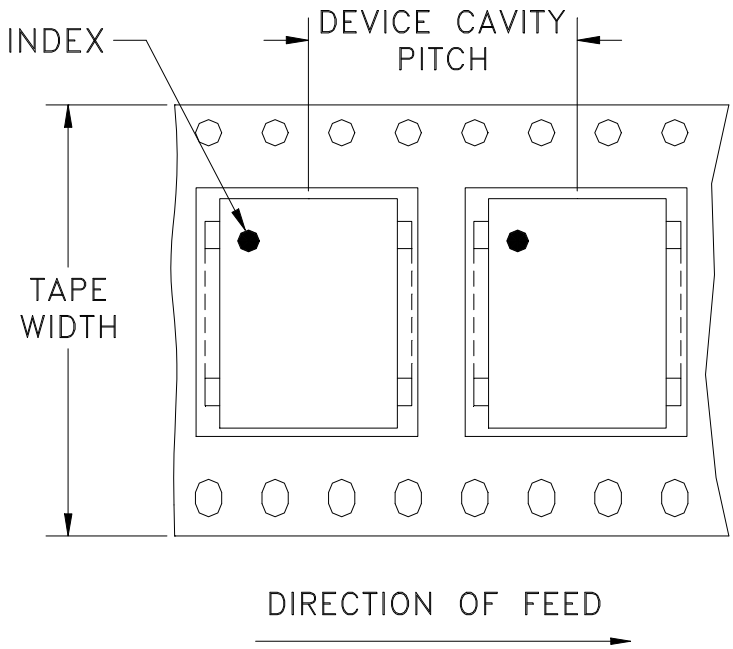
Dimensions are in inches (mm). Tolerances: 2 Pl. ±.015"; 3 Pl. ±.01"

Notes:

1. Case material: Nickel-Silver alloy.
2. Base: Printed wiring laminate.
3. Termination finish:
   For RoHS Case Styles: 2-5 µ inch (.05-.13 microns) Gold over 120-240 µ inch (3.05-6.10 microns) Nickel plate.
   For RoHS-5 Case Styles: Tin-Lead plate.

Tape & Reel Packaging TR-F5

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
32	16	13	500

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

Mini-Circuits®
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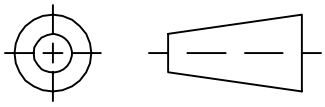
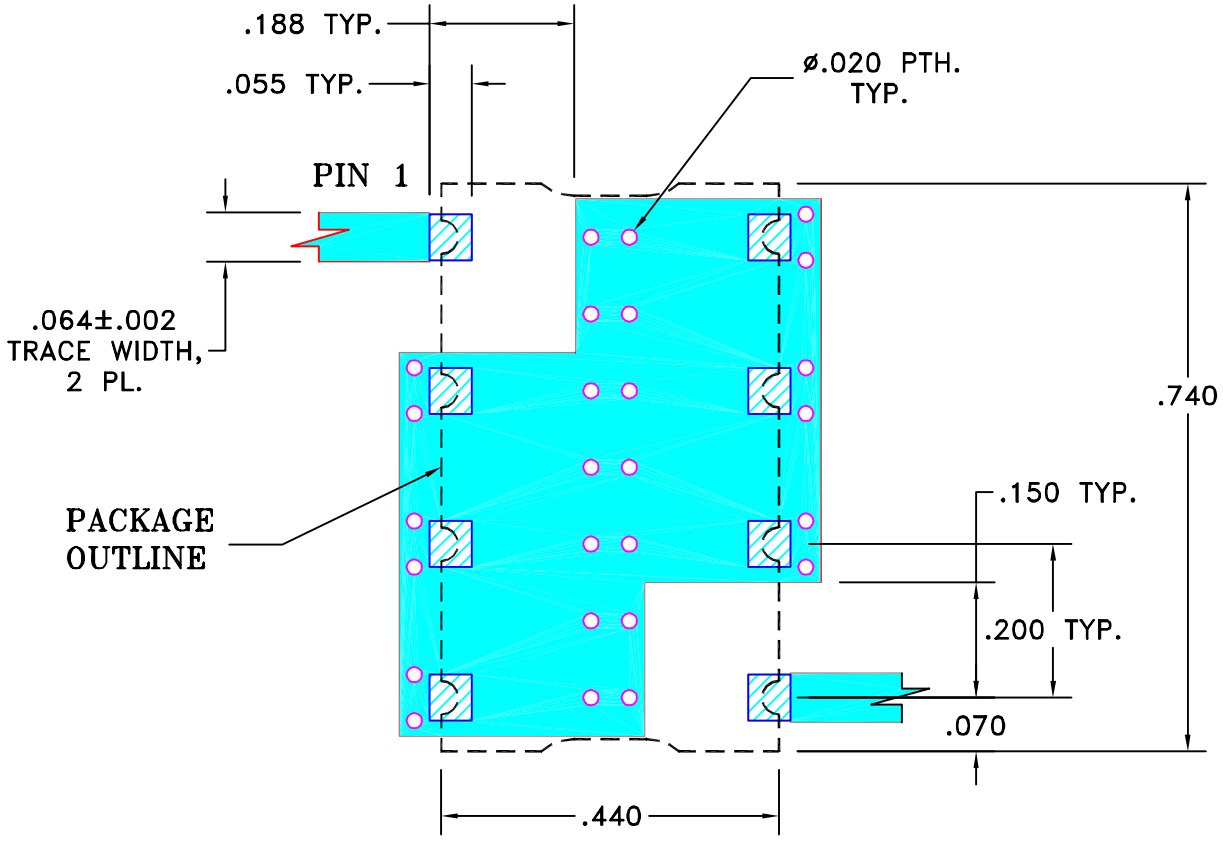
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M101757	NEW RELEASE (FROM RAVON)	11/05	DK	HH
OR	R62293	NEW RELEASE (FROM RAVON)	11/05	DK	HH

SUGGESTED MOUNTING CONFIGURATION
FOR HF1139 CASE STYLE, cr PIN CONNECTION, 50 OHM.



NOTE:

1. TRACE WIDTH IS SHOWN FOR FR4 WITH DIELECTRIC THICKNESS: .025"±.002". COPPER: 1/2 OZ. EACH SIDE.
   FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	DK (RAVON)	29 NOV 05
TOLERANCES ON:	CHECKED	RZ (RAVON)	29 NOV 05
2 PL DECIMALS ±	APPROVED	HH (RAVON)	29 NOV 05
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

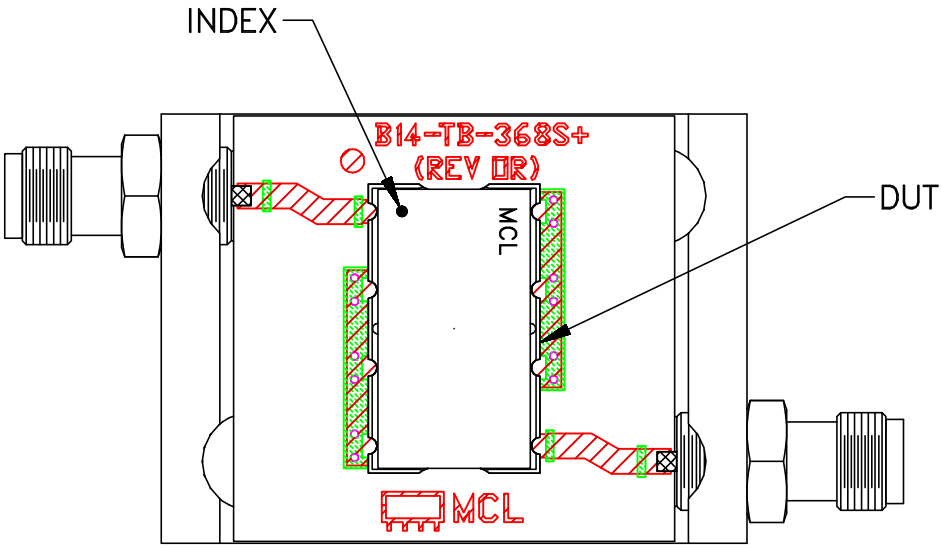
ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

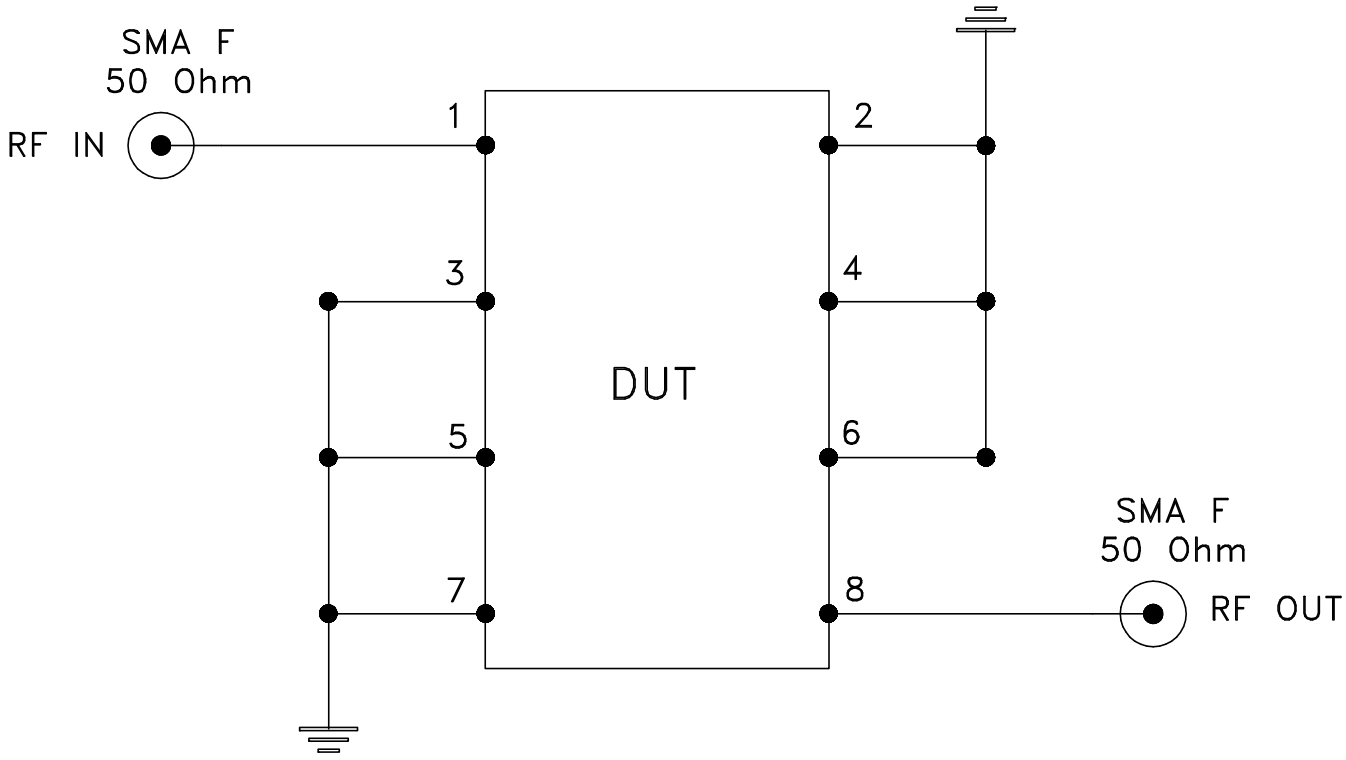
PL, cr, HF1139, SCLF, TB-368

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-230	OR
FILE: 98PL230	SCALE: 4:1	SHEET: 1 OF 1	

Evaluation Board and Circuit



TB-368



Schematic Diagram

Notes:
1. SMA Female connectors.
2. PCB Material: ROGERS R04350B or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

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Environmental Specifications ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215